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		Sixth Semester B.E	. Degree Examina	tion, June/July 2018	•
		ARM Microcon	troller & Emb	edded Systems	1
m:		2.1			1 00
lin	ne:	3 hrs.		Max. Ma	irks: 80
		Note: Answer FIVE full que	stions, choosing one ful	l question from each modul	e. :
				. ,	
1	•	With a post diagram synlain	Module-1	acutox M2 microcontroller	(10.34 - 1-)
1	a. b.	With a neat diagram, explain Explain the register organizat		cortex IVI3 microcontroller.	(10 Marks) (06 Marks)
	٠.		non of Colton 1413.		(00 Marks)
_			OR		
2	a.	Explain the operation modes transition diagram.	and privilege levels ava		: (()
	b. a	Mention the instructions use	d for accessing the spe		(06 Marks)
	(m	suitable examples.		-	(04 Marks)
. 11	(SS)	Explain the stack operations i	using Push and Pop instru	actions in ARM Cortex M3.	(06 Marks)
ST	<i>y</i>	Module-2			
7 3	a.	Explain shift and Rotate instructions available in ARM Cortex M3 instruction set. Why is			
		there rotate right instruction b	out no rotate lest instructi	on in Cortex M32	(08 Marks)
	b.	Explain the following instruc			
		(i) BFC (ii) SXTH	(iii) UBFX (i	v) RBIT	(08 Marks)
			OR		
4 a. Write the memory map and explain memory access attributes in C					(08 Marks)
	b.	b. Analyse the following instructions and write the contents of the registers after the exof each instruction:			execution
		Assume $R8 = 0x00000088$, R	$9 = 0 \times 000000006$ and $R3$	○) = 0x00001111	
		(i) RSB.W R8, R9, #	11 /		<u>;</u>
		(ii) ADD R8, R9, R3			
		(iii) BIC.W R6, R8, #0 (iv) ORR R8, R9	x06		(08 Marks)
		(IV) OKK K6, K9	(C) (P)		(00 Marks)
			Module-3		
5	a.	Differentiate between:			
		(i) RISC and CISC ar (ii) Little Endian and	cnitecture. Big Endian architecture.		(08 Marks)
	b.	What are the features of the fe	•		(55 1111115)
		(i) I2C bus	-		
		(ii) IrDA			
		(iii) Optocoupler (iv) Awire interface			(08 Marks)
		(17) Whe interface			(00 minimy
		<i>∧</i> // })			

15EC62

OR

- What are the different types of memories used in Embedded system design? Explain the ro of each. (08 Mark ()
 - Explain the following circuits in an embedded system:
 - (i) Brown-out protection unit.

(ii) Reset circuit.

(08 Mark -)

Module-4

Explain the term quality attributes in an embedded system development context. What are the different quality attributes to be considered in an embedded system design.

Explain Data flow graph and control data flow graph models in the embedded design.

(08 Mark -)

Explain the different 'Embedded firmware design' approach in detail.

(08 Mark)

Explain, the characteristics of an Embedded system.

(08 Mark:)

Module-5

Explain the concept of 'deadlock' with a neat diagram. Mention the different conditions which favours a deadlock situation. (08 Marks)

Write a block schematic of IDE environment for embedded system design and explain the functions in brief. **⊘(08**Mark∋

OR

Three processes with process IDs P₁, P₂, P₃ with estimated completion time 10, 5, milliseconds respectively enters the ready queue together. A new process P4 with estimate 1 completion time 2 ms enters the 'Ready' queue after 2 ms. Calculate the waiting time for a the processes and the turn around time for all the processes. Also, calculate the average waiting time and average turn around time. The algorithm used is SJF (Shortest Job First) based preemptive scheduling. Assume all the process contain only CPU operation and no I/O operation are involved.

Mention the sequence of operations for embedding the firmware with a programmer and

